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# AKAFLEX® PCL: Copper laminates on a polyester-film backing for flexible printed circuits

## The AKAFLEX® PCL programme

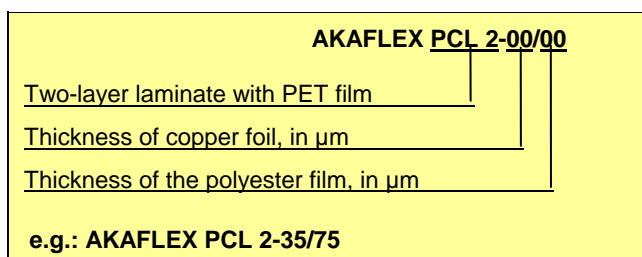
AKAFLEX® PCL is available from KREMPEL as

- ✓ two-layer laminates and
- ✓ three-layer laminates.

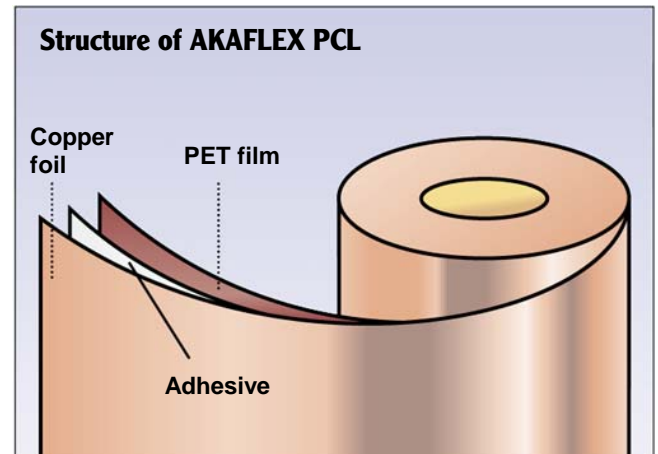
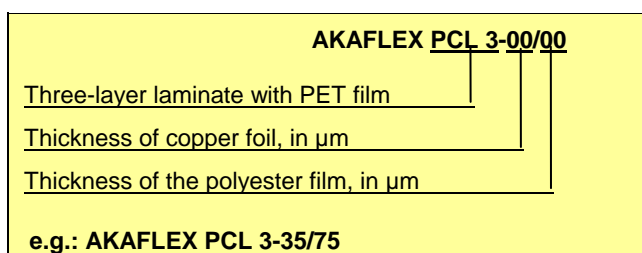
A low-shrinkage polyester film (PET) is used as the backing material for the copper. This is laminated on one or both sides with electrolytic (ED) copper foil. AKAFLEX® PCL is available in various degrees of dimensional stability according to class 1,2 and 3 of IPC specifications. Special types, e.g. laminates with self-adhesive coating (psa types = pressure sensitive adhesive) or laminates with special types of copper foil, are available on request. Only modified **epoxyresin adhesives** are used in the production of these laminates.

AKAFLEX® PCL is manufactured from polyester film and copper foil of differing thickness grades. The various types are identified in the product designation by letters and combinations of numbers.

### Designation for a two-layer laminate



### Designation for a three-layer laminate



### Standard types of AKAFLEX® PCL

Standard-type designation	Thickness of copper foil	Thickness of polyester film
<b>Two-layer laminates</b>		
PCL 2-35/75	35 µm	75 µm
PCL 2-35/100	35 µm	100 µm
PCL 2-35/125	35 µm	125 µm
<b>... with self-adhesive coating</b>		
PCL 2-17/75 psa	17 µm	75 µm
<b>Three-layer laminates</b>		
PCL 3-35/75	35 µm	75 µm

**Other types  
on request**



## Technical data for AKAFLEX® PCL 2-35/75

### 35 µm copper foil / 75 µm polyester film

Laminate properties	Dimension	Test method IPC-TM 650	IPC-4204/5 May 2002	Typical values	
				Class 2	Class 1
<b>Peel strength</b>					
- as delivered	N/mm	2.4.9 B	> 0.88	> 0.88	> 0.88
- after solder dip	N/mm	2.4.9 D	N/A	N/A	N/A
- after temperature cycling	N/mm	2.4.9 F	> 0.7	> 0.7	> 0.89
<b>Tensile strength</b>	N/mm <sup>2</sup>	2.4.19	> 138	> 140	> 140
<b>Failure strain</b>	%	2.4.19	> 70	> 90	> 90
<b>Initial tear strength</b>	N	2.4.16	> 8	> 8	> 8
<b>Flexural strength</b>	cycles	2.4.3 Equipment per 2.4.3.1 Test mandrel: 2 mm	N/A	> 150	> 150
<b>Dimensional stability (after etching and 30 min. at 150 °C)</b>	%	2.2.4 Method C	<b>class 2:</b> ≤ 0.7* <b>class 1:</b> ≤ 1.2*	0.4 -	- 0.9
<b>Solder-bath stability</b>	sec	2.4.13	N/A	N/A	N/A
<b>Dissipation factor (at 1 MHz)</b>	--	ASTM D-150	< 0.02	0.02	0.02

N/A = Not Applicable

\* = classification class 1 to 3 acc. to Krempel specification

## Technical data for AKAFLEX® PCL 2-35/100

### 35 µm copper foil / 100 µm polyester film

Laminate properties	Dimension	Test method IPC-TM 650	IPC-4204/5 May 2002	Typical values		
				Class 3	Class 2	Class 1
<b>Peel strength</b>						
- as delivered	N/mm	2.4.9 B	> 0.88	> 1.0	> 1.0	> 1.0
- after solder dip	N/mm	2.4.9 D	N/A	N/A	N/A	N/A
- after temperature cycling	N/mm	2.4.9 F	> 0.7	> 0.7	> 0.7	> 0.7
<b>Tensile strength</b>	N/mm <sup>2</sup>	2.4.19	> 138	> 140	> 140	> 140
<b>Failure strain</b>	%	2.4.19	> 70	> 90	> 90	> 90
<b>Initial tear strength</b>	N	2.4.16	> 8	> 8	> 8	> 8
<b>Flexural strength</b>	cycles	2.4.3 Equipment per 2.4.3.1 Test mandrel: 2 mm	N/A	> 150	> 150	> 150
<b>Dimensional stability (after etching and 30 min. at 150 °C)</b>	%	2.2.4 Method C	<b>class 3:</b> ≤ 0.4* <b>class 2:</b> ≤ 0.7* <b>class 1:</b> ≤ 1.2*	0.37 - -	- 0.6 -	- - 0.9
<b>Solder-bath stability</b>	sec	2.4.13	N/A	N/A	N/A	N/A
<b>Dissipation factor (at 1 MHz)</b>	--	ASTM D-150	< 0.02	0.02	0.02	0.02

N/A = Not Applicable

\* = classification class 1 to 3 acc. to Krempel specification

## Technical data for AKAFLEX® PCL 2-35/125

### 35 µm copper foil / 125 µm polyester film

Laminate properties	Dimension	Test method IPC-TM 650	IPC-4204/5 May 2002	Typical values	
				Class 2	Class 1
<b>Peel strength</b>					
- as delivered	N/mm	2.4.9 B	> 0.88	> 1.3	> 1.3
- after solder dip	N/mm	2.4.9 D	N/A	N/A	N/A
- after temperature cycling	N/mm	2.4.9 F	> 0.7	> 0.7	> 0.89
<b>Tensile strength</b>	N/mm <sup>2</sup>	2.4.19	> 138	> 140	> 140
<b>Failure strain</b>	%	2.4.19	> 70	> 90	> 90
<b>Initial tear strength</b>	N	2.4.16	> 8	> 8	> 8
<b>Flexural strength</b>	cycles	2.4.3 Equipment per 2.4.3.1			
		Test mandrel: 2 mm	N/A	> 30	> 30
		Test mandrel: 6,34 mm	N/A	> 500	> 500
<b>Dimensional stability (after etching and 30 min. at 150 °C)</b>	%	2.2.4 Method C	<b>class 2:</b> ≤ 0.7* <b>class 1:</b> ≤ 1.2*	0.4 -	- 0.9
<b>Solder-bath stability</b>	sec	2.4.13	N/A	N/A	N/A
<b>Dissipation factor (at 1 MHz)</b>	--	ASTM D-150	< 0.02	0.02	0.02

N/A = Not Applicable

\* = classification class 1 to 3 acc. to Krempel specification

## Technical data for AKAFLEX® PCL 3-35/75

### 35 µm copper foil / 75 µm polyester film / 35 µm copper foil

Laminate properties	Dimension	Test method IPC-TM 650	IPC-4204/5 May 2002	Typical values	
				Class 2	Class 1
<b>Peel strength</b>					
- as delivered	N/mm	2.4.9 B	> 0.88	> 0.88	> 0.88
- after solder dip	N/mm	2.4.9 D	N/A	N/A	N/A
- after temperature cycling	N/mm	2.4.9 F	> 0.7	> 0.7	> 0.89
<b>Tensile strength</b>	N/mm <sup>2</sup>	2.4.19	> 138	> 140	> 140
<b>Failure strain</b>	%	2.4.19	> 70	> 90	> 90
<b>Initial tear strength</b>	N	2.4.16	> 8	> 8	> 8
<b>Flexural strength</b>	cycles	2.4.3 Equipment per 2.4.3.1			
		Test mandrel: 2 mm	N/A	5	5
		Test mandrel: 6.34 mm	N/A	> 50	> 50
<b>Dimensional stability (after etching and 30 min. at 150 °C)</b>	%	2.2.4 Method C	<b>class 2:</b> ≤ 0.7* <b>class 1:</b> ≤ 1.2*	0.4 -	- 0.9
<b>Solder-bath stability</b>	sec	2.4.13	N/A	N/A	N/A
<b>Dissipation factor (at 1 MHz)</b>	--	ASTM D-150	< 0.02	0.02	0.02

N/A = Not Applicable

\* = classification class 1 to 3 acc. to Krempel specification

## Technical data for AKAFLEX® PCL 2-17/75 psa

### 17 µm copper foil / 75 µm polyester film

### with pressure sensitive adhesive coating on one side

Laminate properties	Dimension	Test method IPC-TM 650	IPC-4204/5 May 2002	Typical values
<b>Resin coating:</b> One side, self-adhesive, Tack A, on the polyester-film side	g/m <sup>2</sup>	In-house method	-	According to customer standard
<b>Peel strength</b>				
- as delivered	N/mm	2.4.9	> 0.88	> 0.88
- after solder dip	N/mm	2.4.9	N/A	N/A
- after temperature cycling	N/mm	2.4.9	> 0.7	> 0.7
<b>Tensile strength</b>	N/mm <sup>2</sup>	2.4.19	> 138	> 140
<b>Failure strain</b>	%	2.4.19	> 70	> 90
<b>Initial tear strength</b>	N	2.4.16	> 8	> 8
<b>Flexural strength</b>	cycles	2.4.3 Equipment per 2.4.3.1 Test mandrel 2 mm	N/A	> 150
<b>Dimensional stability</b> (after etching and 30 min. at 150 °C)	%	2.2.4 Method C	<b>class 1: &lt; 1.2*</b>	< 1.2
<b>Solder-bath stability</b>	sec	2.4.13	N/A	N/A

N/A = Not Applicable

\* = classification class 1 to 3 acc. to Krempel specification